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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/748,256	12/27/2000	Howard H. Chen	YO999-153DIV	4783

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EXAMINER

NADAV, ORI

ART UNIT PAPER NUMBER

2811

DATE MAILED: 09/04/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

# Office Action Summary

Application No.

09/748,256

Applicant(s)

CHEN ET AL.

Examiner

ori nadav

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

## Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

## Status

- 1) ☒ Responsive to communication(s) filed on 06 June 2002.
- 2a) ☐ This action is FINAL. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

## Disposition of Claims

- 4) ☒ Claim(s) 29-39 and 41-49 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 29-39 and 41-49 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

## Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on \_\_\_\_\_ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

## Priority under 35 U.S.C. §§ 119 and 120

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- \* See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

## Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO-1449) Paper No(s) \_\_\_\_\_
- 4) ☐ Interview Summary (PTO-413) Paper No(s). \_\_\_\_\_
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other: \_\_\_\_\_

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## **DETAILED ACTION**

### ***Request for Continued Examination***

1. A request for continued examination (RCE) under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 6/6/2002 has been entered. An action on the RCE follows.
2. The amendment filed on 5/15/2002 has been entered.

### ***Claim Rejections - 35 USC § 102***

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

4. Claims 29, 34-36, 41-42 and 45-46 are rejected under 35 U.S.C. 102(b) as being anticipated by Ohata et al. (4,837,186).

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Regarding claims 29, 41, 45 and 46, Ohata et al. teach in figure 8A and related text a hybrid semiconductor device comprising a bulk silicon region (the area beyond the lateral edges of insulator layer 23) comprising single crystal silicon 21, 22 (column 4, lines 18 and 36-37), and an SOI region comprising an insulator layer 23 formed beneath an upper portion of the single crystal silicon 22 and has at least one lateral end portion adjacent to a lower portion of the single crystal silicon, and at least two isolation oxides 37 formed in an upper portion of the single crystal silicon so as to form a plurality of islands of the single crystal silicon on an upper surface of the insulator layer, wherein a sidewall of the insulator layer 23 is angled so that a width of the upper surface of the insulator layer is larger than a width of a lower surface of the insulator layer.

Regarding claims 34 and 42, Ohata et al. teach in figure 8A and related text isolation oxides and insulator layer formed of the same material (column 5, lines 14-15 and 22), wherein the insulator layer is formed only in an SOI region and not in a bulk silicon region of the substrate, because there is no silicon on insulator (SOI) in the bulk region.

Regarding claim 35, Ohata et al. teach in figure 8A an upper surface of the isolation oxides and the single crystal silicon are planarized.

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Regarding claim 36, the single crystal silicon over the insulator layer has the same crystal orientation and structure as that in the bulk silicon region, because it is the same single crystal silicon layer.

***Claim Rejections - 35 USC § 102/103***

5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which the subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

6. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

7. Claims 30, 32-33 and 47-49 are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Ohata et al.

Regarding claims 32, 33, 47, 48 and 30, 49, Ohata et al. teach substantially the entire claimed structure, as applied to claims 29 and 46 above, except forming a crystallized

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silicon layer by depositing and annealing the amorphous silicon, and horizontally growing the single crystal silicon having the same crystal orientation as the insulator layer by using the lower portion of the silicon as a seed, using isolation oxides to remove defects on the SOI region and forming isolation oxides by forming trenches and depositing oxide in the trenches.

Forming a crystallized silicon layer by depositing and annealing the amorphous silicon, and horizontally growing the single crystal silicon having the same crystal orientation as the insulator layer by using the lower portion of the silicon as a seed, using isolation oxides to remove defects on the SOI region and forming isolation oxides by forming trenches and depositing oxide in the trenches, as recited in claims 32, 33, 47, 48 and 30, 49, are processing limitations which would not carry patentable weight in this claim drawn to a structure, because distinct structure is not necessarily produced. Note that a "product by process" claim is directed to the product per se, no matter how actually made, *In re Hirao*, 190 USPQ 15 at 17 (footnote 3). See also *In re Brown*, 173 USPQ 685; *In re Luck*, 177 USPQ 523; *In re Fessmann*, 180 USPQ 324; *In re Avery*, 186 USPQ 161; *In re Wertheim*, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); and *In re Marosi et al.*, 218 USPQ 289, all of which make it clear that it is the patentability of the final product per se which must be determined in a "product by process" claim, and not the patentability of the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in

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“product by process” claims or not. Note that the applicant has the burden of proof in such cases, as the above case law makes clear.

***Claim Rejections - 35 USC § 103***

8. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which the subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

9. Claim 31 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ohata et al.

Regarding claim 31, Ohata does not teach an insulator layer having a thickness in the range of 1000A to 5000A. it would have been obvious to a person of ordinary skill in the art at the time the invention was made to use an insulator layer having a thickness in the range of 1000A to 5000A in Ohata's device, because it is well within the skills of an artisan to optimize the performance of the device by forming the insulator layer at the required thickness.

10. Claims 37-39 and 43-44 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ohata et al. in view of Tanaka (Jp 10-303385).

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Regarding claims 37-39 and 43-44, Ohata et al. teach substantially the entire claimed structure, as applied to claims 29, 41 and 42 above, except forming a DRAM memory device on the silicon bulk and a MOSFET logic device on the SOI region.

Tanaka teaches in figure 1f a DRAM memory device 11 on the silicon bulk and a MOSFET logic device 13 on the SOI region.

It would have been obvious to a person of ordinary skill in the art at the time the invention was made to form a DRAM memory device on the silicon bulk and a MOSFET logic device on the SOI region, as taught by Tanaka, in Ohata et al.'s device in order to provide a hybrid device wherein the DRAM can operate at high speed with less power consumption and the logic circuits are adequately isolated.

### ***Response to Arguments***

11. Applicant's arguments with respect to claims 29-39 and 41-45 have been considered but are moot in view of the new ground(s) of rejection.



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Papers related to this application may be submitted to Technology center (TC) 2800 by facsimile transmission. Papers should be faxed to TC 2800 via the TC 2800 Fax center located in Crystal Plaza 4, room 4-C23. The faxing of such papers must conform with the notice published in the Official Gazette, 1096 OG 30 (November 15, 1989). The Group 2811 Fax Center number is (703) 308-7722 and 308-7724. The Group 2811 Fax Center is to be used only for papers related to Group 2811 applications.

Any inquiry concerning this communication or any earlier communication from the Examiner should be directed to *Examiner Nadav* whose telephone number is (703) 308-8138. The Examiner is in the Office generally between the hours of 7 AM to 4 PM (Eastern Standard Time) Monday through Friday. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas, can be reached at (703) 308-2772.

Any inquiry of a general nature or relating to the status of this application should be directed to the **Technology Center Receptionists** whose telephone number is 308-

0956

A handwritten signature in black ink, appearing to read 'Ori Nadav', written in a cursive style.

Ori Nadav

August 29, 2002